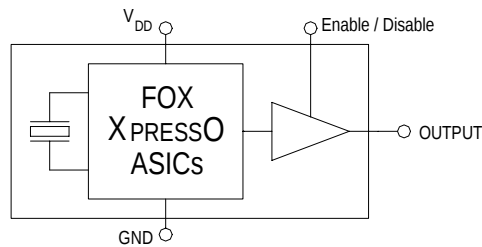


## Features

- XTREMELY Low Jitter
- Low Cost
- XPRESS Delivery
- Frequency Resolution to six decimal places
- Stabilities to  $\pm 25$  PPM
- -20 to +70°C or -40 to +85°C operating temperatures
- Tri-State Enable / Disable Feature
- Industry Standard Package, Footprint & Pin-Out
- Fully RoHS and REACH compliant
- Gold over Nickel Termination Finish
- Serial ID with Comprehensive Traceability



For more information -- Click on the drawing

## Description

The Fox XPRESSO Crystal Oscillator is a breakthrough in configurable Frequency Control Solutions. XPRESSO utilizes a family of proprietary ASICs, designed and developed by Fox, with a key focus on noise reduction technologies.

The 3<sup>rd</sup> order Delta Sigma Modulator reduces noise to the levels that are comparable to traditional Bulk Quartz and SAW oscillators. The ASICs family has ability to select the output type, input voltages, and temperature performance features.

With the XPRESS lead-time, low cost, low noise, wide frequency range, excellent ambient performance, XpressO is an excellent choice over the conventional technologies.

Finished XPRESSO parts are 100% final tested.



## Applications

- ANY application requiring an oscillator
- SONET
- Ethernet
- Storage Area Network
- Broadband Access
- Microprocessors / DSP / FPGA
- Industrial Controllers
- Test and Measurement Equipment
- Fiber Channel

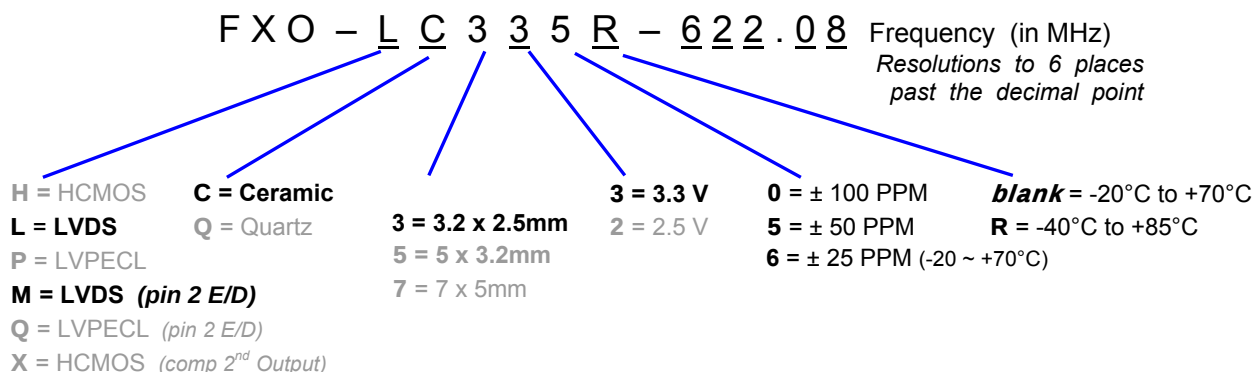
## Contents

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## Model Selection Guide & Fox Part Number

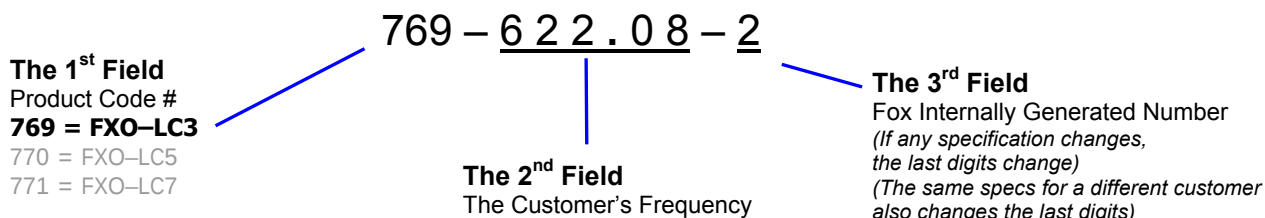
**STEP #1:** Customer selects the Model Description and provides to Fox Customer Service

### Model Description



**STEP #2:** The Fox Customer Service team provides a customer specific Part Number for use on their Bill Of Materials (BOM).

**Fox Part Number** (The assigned Fox Part Number must be on the BOM – not the above Model Description)  
 (This will ensure receipt of the proper part)



This example, **FXO-LC335R-622.08** = LVDS Output, Ceramic, 3.2 x 2.5mm Package, 3.3V, ±50 PPM Stability, -40 to +85°C Temperature Range, at 622.08 MHz

## Electrical Characteristics

| Parameters                        | Symbol                             | Condition                                                                                                                                                    | Maximum Value<br>(unless otherwise noted)                 |
|-----------------------------------|------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------|
| Frequency Range                   | F <sub>O</sub>                     |                                                                                                                                                              | 0.750 MHz to 1.35 GHz                                     |
| Frequency Stability <sup>1</sup>  |                                    | 0.75 ~ 630.000 MHz (-20 to +70°C)<br>0.75 ~ 630.000 MHz (-40 to +85°C)<br>630.000+ MHz ~ 1.350 GHz (-20 to +70°C)<br>630.000+ MHz ~ 1.350 GHz (-40 to +85°C) | 100, 50, 25* PPM<br>100, 50 PPM<br>100, 50 PPM<br>100 PPM |
| Temperature Range                 | T <sub>O</sub><br>T <sub>STG</sub> | Standard operating<br>Optional operating<br>Storage                                                                                                          | -20°C to +70°C<br>-40°C to +85°C<br>-55°C to +125°C       |
| Supply Voltage                    | V <sub>DD</sub>                    | Standard                                                                                                                                                     | 3.3 V ± 5%                                                |
| Input Current<br>(@ 100 Ohm Load) | I <sub>DD</sub>                    | Standard Load                                                                                                                                                | 100 mA                                                    |
| Output Load                       |                                    | Standard                                                                                                                                                     | 100 Ohms Typ.                                             |
| Start-Up Time                     | T <sub>S</sub>                     |                                                                                                                                                              | 10 mS                                                     |
| Output Enable / Disable<br>Time   |                                    |                                                                                                                                                              | 100 nS                                                    |
| Moisture Sensitivity Level        | MSL                                | JEDEC J-STD-20                                                                                                                                               | 1                                                         |
| Termination Finish                |                                    |                                                                                                                                                              | Au                                                        |

<sup>1</sup>Inclusive of 25°C tolerance, operating temperature range, input voltage change, load change, aging, shock and vibration. \*Excludes aging.

## Absolute Maximum Ratings (Useful life may be impaired. For user guidelines only, not tested)

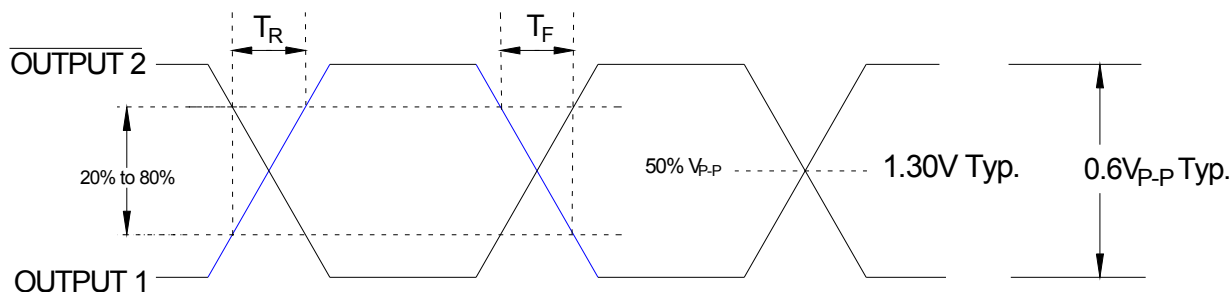
| Parameters            | Symbol            | Condition        | Maximum Value<br>(unless otherwise noted) |
|-----------------------|-------------------|------------------|-------------------------------------------|
| Input Voltage         | V <sub>DD</sub>   |                  | -0.5V to +5.0V                            |
| Operating Temperature | T <sub>AMAX</sub> |                  | -55°C to +105°C                           |
| Storage Temperature   | T <sub>STG</sub>  |                  | -55°C to +125°C                           |
| Junction Temperature  |                   |                  | 150°C                                     |
| ESD Sensitivity       | HBM               | Human Body Model | > 1 kV                                    |

## Output Wave Characteristics

| Parameters                                        | Symbol   | Condition             | Maximum Value<br>(unless otherwise noted) |
|---------------------------------------------------|----------|-----------------------|-------------------------------------------|
| Differential Output Voltage                       | $V_{OD}$ | 0.75 MHz to 1.35 GHz  | 0.6V Typ.                                 |
| Output Offset Voltage                             | $V_{OS}$ | Volts DC              | 1.3V Typ.                                 |
| Output Symmetry (See Drawing Below)               |          | @ 50% $V_{P-P}$ Level | 45% ~ 55%                                 |
| Output Enable (PIN # 1) Voltage <sup>Note1</sup>  | $V_{IH}$ |                       | $\geq 70\% V_{DD}$                        |
| Output Disable (PIN # 1) Voltage <sup>Note1</sup> | $V_{IL}$ |                       | $\leq 30\% V_{DD}$                        |
| Cycle Rise Time (See Drawing Below)               | $T_R$    | 20%~80% Vp-p          | 400 pS                                    |
| Cycle Fall Time (See Drawing Below)               | $T_F$    | 80%~20% Vp-p          | 400 pS                                    |

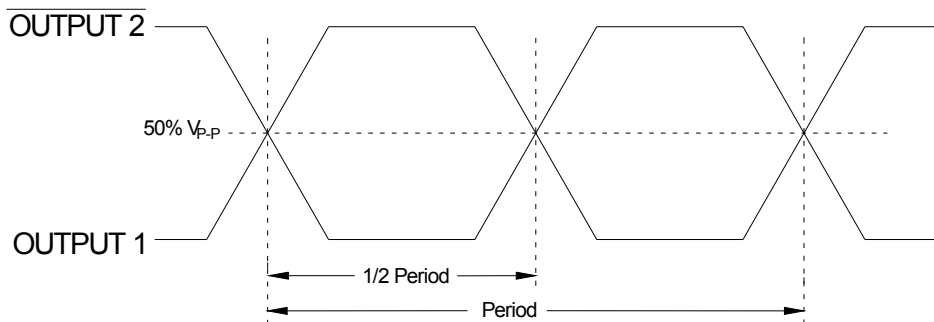
<sup>Note1</sup> An optional PIN # 2 as Enable / Disable is available – see Model Selection Guide (page 2)

### Rise Time / Fall Time Measurements

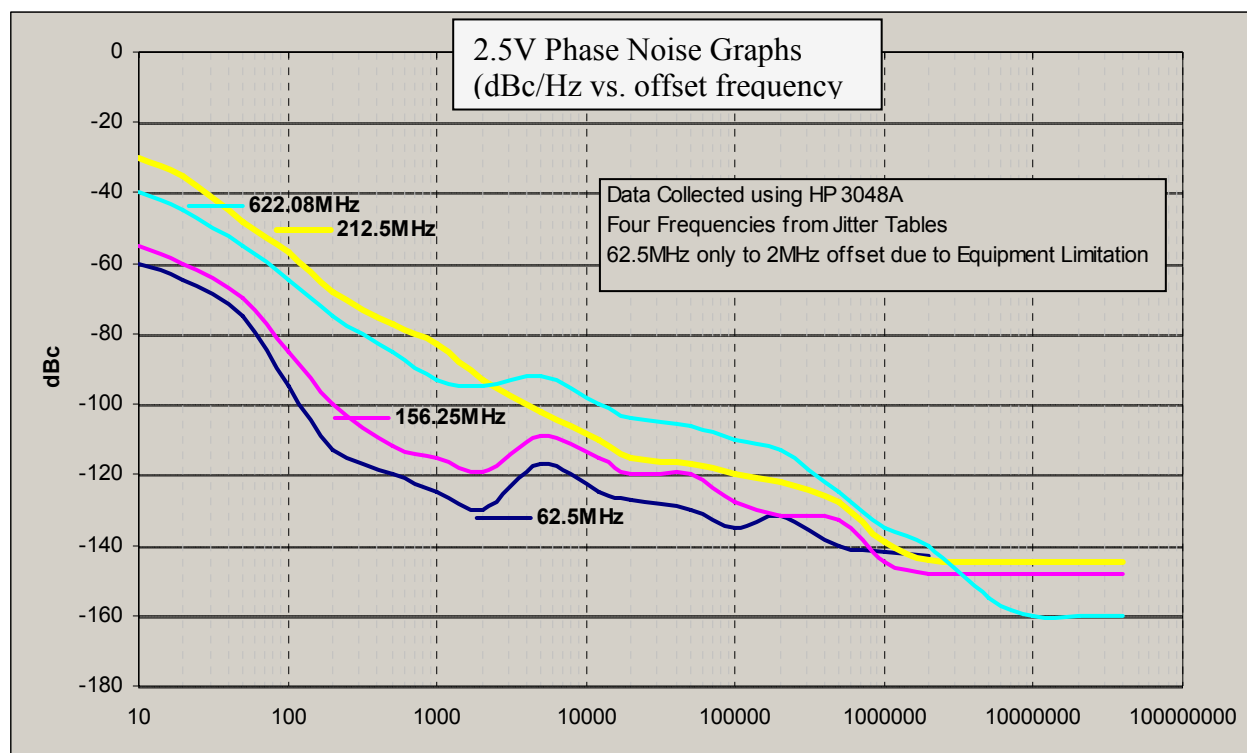


### Oscillator Symmetry

Ideally, Symmetry should be 50/50 for 1/2 period -- Other expressions are 45/55 or 55/45



## Phase Noise



Jitter is frequency dependent. Below are typical values at select frequencies.

### LVDS Phase Jitter & Time Interval Error (TIE)

| Frequency  | Phase Jitter<br>(12kHz to 20MHz) | TIE<br>(Sigma of Jitter Distribution) | Units  |
|------------|----------------------------------|---------------------------------------|--------|
| 62.5 MHz   | 1.3                              | 2.6                                   | pS RMS |
| 156.25 MHz | 0.6                              | 4.3                                   | pS RMS |
| 212.5 MHz  | 0.8                              | 5.0                                   | pS RMS |
| 622.08MHz  | 0.7                              | 2.4                                   | pS RMS |

**Phase Jitter** is integrated from HP3048 Phase Noise Measurement System; measured directly into 50 ohm input;  $V_{DD} = 3.3V$ .

**TIE** was measured on LeCroy LC684 Digital Storage Scope, directly into 50 ohm input, with Amherst M1 software;  $V_{DD} = 3.3V$ .

*Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)*

### LVDS Random & Deterministic Jitter Composition

| Frequency  | Random (Rj)<br>(pS RMS) | Deterministic (Dj)<br>(pS P-P) | Total Jitter (Tj)<br>(14 x Rj) + Dj |
|------------|-------------------------|--------------------------------|-------------------------------------|
| 62.5 MHz   | 1.2                     | 11.9                           | 29.1 pS                             |
| 156.25 MHz | 1.2                     | 11.2                           | 28.4 pS                             |
| 212.5 MHz  | 1.2                     | 12.7                           | 29.8 pS                             |
| 622.08 MHz | 1.0                     | 9.4                            | 24.5 pS                             |

**Rj and Dj**, measured on LeCroy LC684 Digital Storage Scope, directly into 50 ohm input, with Amherst M1 software.

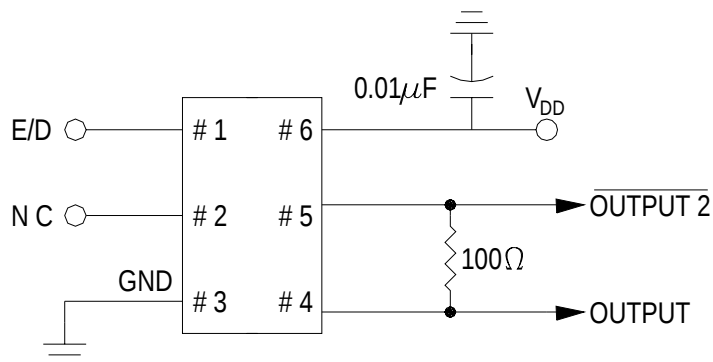
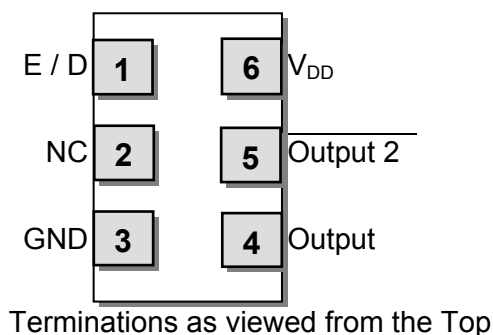
*Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)*

## Pin Description and Recommended Circuit

| Pin # | Name                         | Type   | Function                                          |
|-------|------------------------------|--------|---------------------------------------------------|
| 1     | E / D <sup>1</sup>           | Logic  | Enable / Disable Control of Output (0 = Disabled) |
| 2     | NC                           |        | No Connection – Leave OPEN                        |
| 3     | GND                          | Ground | Electrical Ground for V <sub>DD</sub>             |
| 4     | Output                       | Output | LVDS Oscillator Output                            |
| 5     | Output 2                     | Output | Complementary LVDS Output                         |
| 6     | V <sub>DD</sub> <sup>2</sup> | Power  | Power Supply Source Voltage                       |

### NOTES:

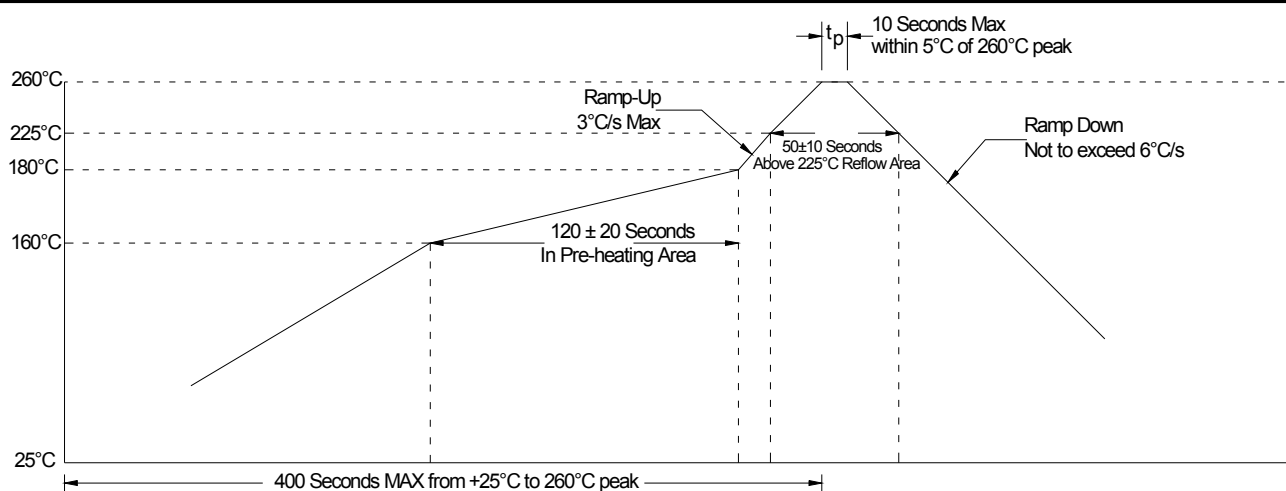
- <sup>1</sup> Includes pull-up resistor to V<sub>DD</sub> to provide output when the pin (1) is No Connect.
- <sup>2</sup> Installation should include a 0.01μF bypass capacitor placed between V<sub>DD</sub> (Pin 6) and GND (Pin 3) to minimize power supply line noise.



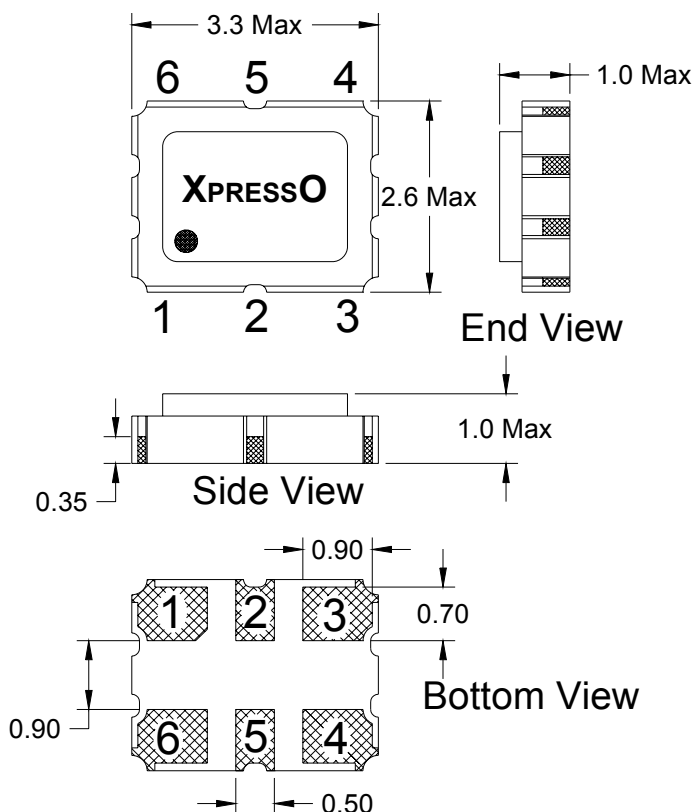
## Enable / Disable Control

| Pin # 1 (state)                     | Output (Pin # 4, Pin # 5) |
|-------------------------------------|---------------------------|
| OPEN (No Connection)                | ACTIVE Output             |
| "1" Level $V_{IH} \geq 70\% V_{DD}$ | ACTIVE Output             |
| "0" Level $V_{IL} \leq 30\% V_{DD}$ | High Impedance            |

## Soldering Reflow Profile (2 times Maximum at 260°C for 10 seconds MAX)



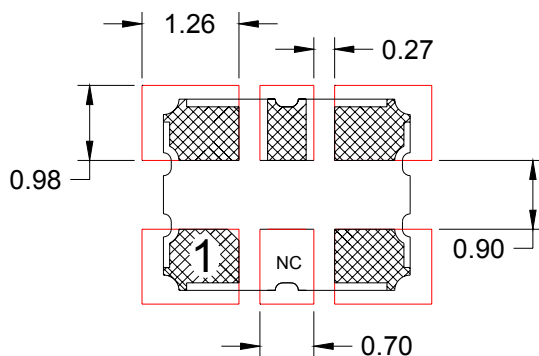
# Mechanical Dimensional Drawing & Pad Layout



**Actual part marking is depicted.**

See **Traceability** (pg. 9) for more information

## Recommended Solder Pad Layout

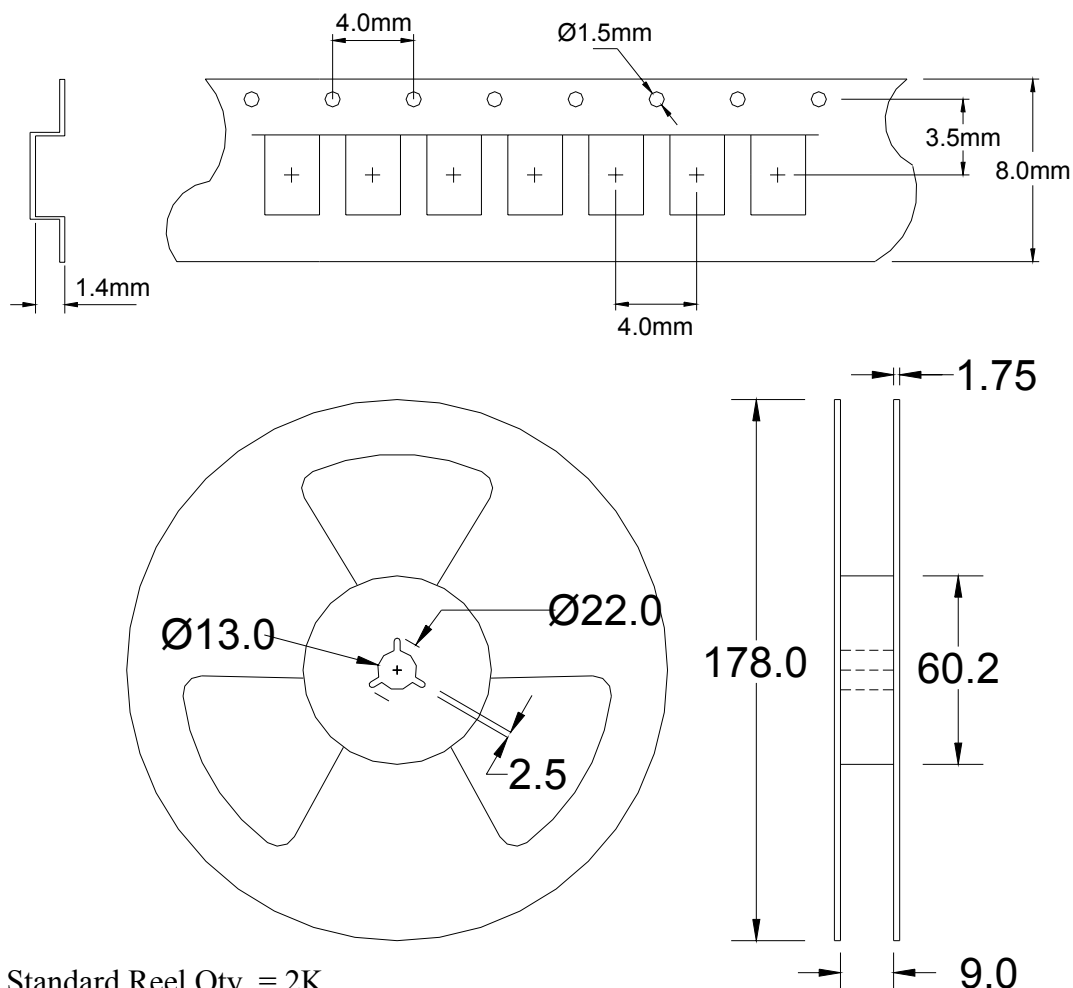


### Pin Connections

|           |                        |
|-----------|------------------------|
| # 1 E / D | # 4 V <sub>OUT 1</sub> |
| # 2 N.C.  | # 5 V <sub>OUT 2</sub> |
| # 3 GND   | # 6 V <sub>DD</sub>    |

Drawing is for reference to critical specifications defined by size measurements.  
Certain non-critical visual attributes, such as side castellations, reference pin shape, etc. may vary

## Tape and Reel Dimensions



Standard Reel Qty. = 2K

## Labeling (Reels and smaller packaging are labeled with the below)

- Fox Part Number: **769-622.08-2** →
- Quantity: **2000 pieces** →
- Description: **FXO-LC335R-622.08** →
- Date Code: **0745** →  
(YYWW 2007 45<sup>th</sup> wk)
- LOT #: **24435** →  
*If traceability should become necessary*

SKU **769-622.08-2**

QTY: **2000**

DESC **FXO-LC335R-622.08**

DATE CODE: **0745**

LOT: **24435**

**FOX**  
Xpress0®

Covered by one or more of listed  
U.S. Patents: 6,664,860, 5,960,403  
5,960,405 5,952,890 6,188,290

Foreign Patents:  
China ZL 98802217.6 Mexico 23277  
R.S.A. 98/0866, ROC 120851,  
Singapore 67081; 67082,  
EP 0958652 Hong Kong HK1026079  
Malaysia MY-118540-A  
Philippines Patent: 1-1998-000246  
US and Foreign Patents Pending

**Pb-Free  
RoHS Compliant  
Category (e4)**

Xpress0® is a Registered Trademark of Fox Electronics

An additional identification code is contained internally if tracking should ever be necessary

## Traceability – LOT Number & Serial Identification

### LOT Number

The LOT Number has direct ties to the customer purchase order. The LOT Number is marked on the “Reel” label, and also stored internally on non-volatile memory inside the XPRESSO part. XPRESSO parts that are shipped Tape and Reel, are also placed in an Electro Static Discharge (ESD) bag and will have the LOT Number labeled on the exterior of the ESD bag.

It is recommended that the XPRESSO parts remain in this ESD bag during storage for protection and identification.

If the parts become separated from the label showing the LOT Number, it can be retrieved from inside one of the parts, and the information that can be obtained is listed below:

- Customer Purchase Order Number
- Internal Fox Sales Order Number
- Dates that the XPRESSO part was shipped from the factory
- The assigned customer part number
- The specification that the part was designed for

---

### Serial Identification

The Serial ID is the individualized information about the configuration of that particular XPRESSO part. The Serial ID is unique for each and every XPRESSO part, and can be read by special Fox equipment.

With the Serial ID, the below information can be obtained about that individual, XPRESSO part:

- Equipment that the XPRESSO part was configured on
- Raw material used to configure the XPRESSO part
- Traceability of the raw material back to the foundries manufacturing lot
- Date and Time that the part was configured
- Any optimized electrical parameters based on customer specifications
- Electrical testing of the actual completed part
- Human resource that was monitoring the configuration of the part

Fox has equipment placed at key Fox locations World Wide to read the Lot Identification and Serial Number of any XPRESSO part produced and can then obtain the information from above within 24 hours

**3<sup>rd</sup> Party (SGS) Material Report**

**Test Report**

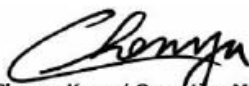
No. : CE/2008/63138    Date : 2008/06/19    Page : 1 of 4

 FOX ELECTRONICS  
 5570 ENTERPRISE PARKWAY FT. MYERS, FL 33905, USA


The following sample(s) was/were submitted and identified by/on behalf of the client as :

|                       |   |                             |
|-----------------------|---|-----------------------------|
| Sample Description    | : | XPRESSO CERAMIC OSCILLATORS |
| Style/Item No.        | : | SEAM SEAL CLOCK OSCILLATOR  |
| Buyer/Order No.       | : | 47454                       |
| Sample Receiving Date | : | 2008/06/12                  |
| Testing Period        | : | 2008/06/12 TO 2008/06/19    |

 =====  
 Test Result(s) : Please refer to next page(s).


**Chenyu Kung / Operation Manager**  
 Signed for and on behalf of  
**SGS TAIWAN LTD.**  
 Chemical Laboratory – Taipei

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| 台灣檢驗科技股份有限公司           | t (886-2) 2299-3939    f (886-2) 2299-3237 <a href="http://www.tw.sgs.com">www.tw.sgs.com</a> |

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**3<sup>rd</sup> Party (SGS) Material Report (continued)**

**Test Report**

No. : CE/2008/63138 Date : 2008/06/19 Page : 2 of 4

 FOX ELECTRONICS  
 5570 ENTERPRISE PARKWAY FT. MYERS, FL 33905, USA

**Test Result(s)**

PART NAME NO.1 : MIXED ALL PARTS

| Test Item (s):                                    | Unit  | Method                                                                                                                                  | MDL | Result No.1 |
|---------------------------------------------------|-------|-----------------------------------------------------------------------------------------------------------------------------------------|-----|-------------|
| Cadmium (Cd)                                      | mg/kg | With reference to IEC 62321/2nd CDV (111/95/CDV). Determination of Cadmium by ICP-AES.                                                  | 2   | n.d.        |
| Lead (Pb)                                         | mg/kg | With reference to IEC 62321/2nd CDV (111/95/CDV). Determination of Lead by ICP-AES.                                                     | 2   | n.d.        |
| Mercury (Hg)                                      | mg/kg | With reference to IEC 62321/2nd CDV (111/95/CDV). Determination of Mercury by ICP-AES.                                                  | 2   | n.d.        |
| Hexavalent Chromium Cr(VI) by alkaline extraction | mg/kg | With reference to IEC 62321/2nd CDV (111/95/CDV). Determination of Hexavalent Chromium for non-metallic samples by UV/Vis Spectrometry. | 2   | n.d.        |
| Halogen                                           | ---   | With reference to BS EN 14582:2007. Analysis was performed by IC method for F, Cl, Br, I content.                                       | --- | ---         |
| Halogen-Fluorine (F)<br>(CAS No.: 007782-41-4)    | mg/kg | With reference to BS EN 14582:2007. Analysis was performed by IC method for Fluorine content.                                           | 50  | n.d.        |
| Halogen-Chlorine (Cl)<br>(CAS No.: 007782-50-5)   | mg/kg | With reference to BS EN 14582:2007. Analysis was performed by IC method for Chlorine content.                                           | 50  | n.d.        |
| Halogen-Bromine (Br)<br>(CAS No.: 007726-95-6)    | mg/kg | With reference to BS EN 14582:2007. Analysis was performed by IC method for Bromine content.                                            | 50  | n.d.        |
| Halogen-Iodine (I)<br>(CAS No.: 007553-56-2)      | mg/kg | With reference to BS EN 14582:2007. Analysis was performed by IC method for Iodine content.                                             | 50  | n.d.        |

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**3<sup>rd</sup> Party (SGS) Material Report (continued)**

**Test Report**

No. : CE/2008/63138 Date : 2008/06/19 Page : 3 of 4

 FOX ELECTRONICS  
 5570 ENTERPRISE PARKWAY FT. MYERS, FL 33905, USA


| Test Item (s):              | Unit  | Method                                                                                    | MDL | Result<br>No.1 |
|-----------------------------|-------|-------------------------------------------------------------------------------------------|-----|----------------|
| Sum of PBBs                 |       |                                                                                           | -   | n.d.           |
| Monobromobiphenyl           |       |                                                                                           | 5   | n.d.           |
| Dibromobiphenyl             |       |                                                                                           | 5   | n.d.           |
| Tribromobiphenyl            |       |                                                                                           | 5   | n.d.           |
| Tetrabromobiphenyl          |       |                                                                                           | 5   | n.d.           |
| Pentabromobiphenyl          |       |                                                                                           | 5   | n.d.           |
| Hexabromobiphenyl           |       |                                                                                           | 5   | n.d.           |
| Heptabromobiphenyl          |       |                                                                                           | 5   | n.d.           |
| Octabromobiphenyl           |       |                                                                                           | 5   | n.d.           |
| Nonabromobiphenyl           |       |                                                                                           | 5   | n.d.           |
| Decabromobiphenyl           |       |                                                                                           | 5   | n.d.           |
| Sum of PBDEs (Mono to Nona) | mg/kg | With reference to IEC 62321/2nd CDV (111/95/CDV). Determination of PBB and PBDE by GC/MS. | -   | n.d.           |
| Monobromodiphenyl ether     |       |                                                                                           | 5   | n.d.           |
| Dibromodiphenyl ether       |       |                                                                                           | 5   | n.d.           |
| Tribromodiphenyl ether      |       |                                                                                           | 5   | n.d.           |
| Tetrabromodiphenyl ether    |       |                                                                                           | 5   | n.d.           |
| Pentabromodiphenyl ether    |       |                                                                                           | 5   | n.d.           |
| Hexabromodiphenyl ether     |       |                                                                                           | 5   | n.d.           |
| Heptabromodiphenyl ether    |       |                                                                                           | 5   | n.d.           |
| Octabromodiphenyl ether     |       |                                                                                           | 5   | n.d.           |
| Nonabromodiphenyl ether     |       |                                                                                           | 5   | n.d.           |
| Decabromodiphenyl ether     |       |                                                                                           | 5   | n.d.           |
| Sum of PBDEs (Mono to Deca) |       |                                                                                           | -   | n.d.           |

- Note : 1. mg/kg = ppm  
 2. n.d. = Not Detected  
 3. MDL = Method Detection Limit  
 4. "—" = Not Conducted  
 5. " - " = Not Regulated  
 6. The sample(s) was/were analyzed on behalf of the applicant as mixing sample in one testing.  
 The above result(s) was/were only given as the informality value.

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**3<sup>rd</sup> Party (SGS) Material Report (continued)**

**Test Report**

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 5570 ENTERPRISE PARKWAY FT. MYERS, FL 33905, USA


\*\* End of Report \*\*

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**SGS Taiwan Ltd.**  
 台灣檢驗科技股份有限公司

 No. 33 Wu Chyuan Road, Wuku Industrial Zone, Taipei County, Taiwan / 台北縣五股工業區五權路33號  
 t (886-2) 2299-3939    f (886-2) 2299-3237    www.tw.sgs.com

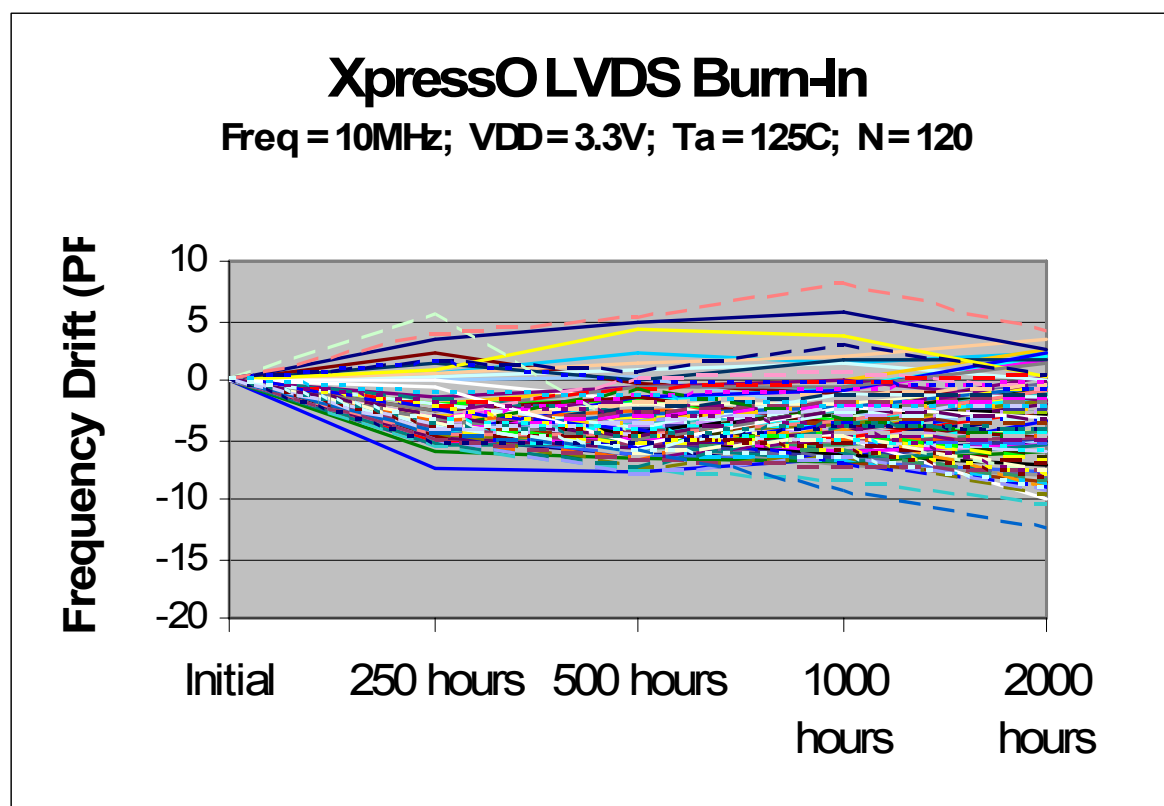
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## Mechanical Testing

| Parameter                | Test Method                                                                        |
|--------------------------|------------------------------------------------------------------------------------|
| Mechanical Shock         | Drop from 75cm to hardwood surface – 3 times                                       |
| Mechanical Vibration     | 10~55Hz, 1.5mm amplitude, 1 Minute Sweep<br>2 Hours each in 3 Directions (X, Y, Z) |
| High Temperature Burn-in | Under Power @ 125°C for 2000 Hours (results below)                                 |
| Hermetic Seal            | He pressure: 4 ±1 kgf / cm <sup>2</sup> 2 Hour soak                                |

## 2,000 Hour Burn-In

**Burn-In Testing** – under power 2000 Hours, 125°C



## MTTF / FITS Calculations

Products are grouped together by process for MTTF calculations.  
(All XpressO output and package types are manufactured with the same process)

Number of Parts Tested: 360 (120 of each output type: HCMOS, LVDS, LVPECL)  
Number of Failures: 0  
Test Temperature: 125°C  
Number of Hours: 2000

MTTF was calculated using the following formulas:

[1.] Device Hours (*devhrs*) = (number of devices) x (hours at elevated temperature in °K)

$$[2.] MTTF = \frac{devhrs \times af \times 2}{\chi^2}$$

$$[3.] FITS = \frac{1}{MTTF} * 10^9$$

Where:

| Label                | Name                | Formula/Value                                                                                                                                                                                                   |
|----------------------|---------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <i>af</i>            | Acceleration Factor | $e^{\left(\frac{eV}{k}\right) \times \left(\frac{1}{t_1} - \frac{1}{t_2}\right)}$                                                                                                                               |
| <i>eV</i>            | Activation Energy   | 0.40 V                                                                                                                                                                                                          |
| <i>k</i>             | Bolzman's Constant  | 8.62 X 10 <sup>-5</sup> eV/°K                                                                                                                                                                                   |
| <i>t<sub>1</sub></i> |                     | Operating Temperature (°K)                                                                                                                                                                                      |
| <i>t<sub>2</sub></i> |                     | Accelerated Temperature (°K)                                                                                                                                                                                    |
| $\Theta$             | Theta               | Confidence Level (60% industry standard)                                                                                                                                                                        |
| <i>r</i>             | Failures            | Number of failed devices                                                                                                                                                                                        |
| $\chi^2$             | Chi-Square          | statistical significance for bivariate tabular analysis [table look-up] based on assumed $\Theta$ (Theta – confidence) and number of failures ( <i>r</i> ) For zero failures (60% Confidence): $\chi^2 = 1.830$ |

$$DEVICE-HOURS = 360 \times 2000 \text{ HOURS} = 720,000$$

$$ACCELERATION FACTOR = e^{\left(\frac{0.40}{8.625}\right) \times \left(\frac{1}{298} - \frac{1}{398}\right)} = 49.91009$$

$$MTTF = \frac{720,000 \times 49.91009 \times 2}{1.833} = 39,209,238 \text{ Hours}$$

$$\text{Failure Rate} = \frac{1.833}{720,000 \times 49.91009 \times 2} = 2.55E-8$$

$$FITS = \text{Failure Rate} * 1E9 = 26$$

**Notes :**

Patent Numbers:  
US 6,664,860, US 5,960,403, US 5,952,890; US 5,960,405; US 6,188,290;  
Foreign Patents: R.S.A. 98/0866, R.O.C. 120851; Singapore 67081, 67082; EP 0958652  
China ZL 98802217.6, Malaysia MY-118540-A, Philippines 1-1998-000245, Hong Kong #HK1026079, Mexico #232179  
US and Foreign Patents Pending  
XpressO™ Fox Electronics

**Contact Information****(USA)-Worldwide Headquarters**

Tel: 888-GET-2-FOX

Outside US: +1.239.693.0099,

Fax: +1.239.693.1554

Email: [www.foxonline.com/email.htm](http://www.foxonline.com/email.htm)**Fox Japan**

Tel: +81.3.3374.2079,

Fax: +81.3.3377.5221

Email: [www.foxonline.com/email.htm](http://www.foxonline.com/email.htm)**Fox EMEA**

Tel/Fax: +44 1283 568153

Email: [www.foxonline.com/email.htm](http://www.foxonline.com/email.htm)

The above specifications, having been carefully prepared and checked, is believed to be accurate at the time of publication; however, no responsibility is assumed by Fox Electronics for inaccuracies.

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### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9